### 1. General description

Nexperia introduces leading edge Silicon Carbide (SiC) Schottky diode for ultra high performance, low loss, high efficiency power conversion applications. The SiC Schottky diode encapsulated in a Real-2-Pin D2PAK R2P (TO-263-2) Surface-Mounted Device (SMD) power plastic package offers temperature independent capacitive turn-off, zero recovery switching behavior combined with an outstanding figure-of-merit ( $Q_C \times V_F$ ). The Merged PiN Schottky (MPS) diode improves the robustness expressed in a high  $I_{FSM}$ .

#### 2. Features and benefits

- Zero forward and reverse recovery
- · Temperature independent fast and smooth switching performance
- Outstanding figure of merit (Q<sub>c</sub> x V<sub>F</sub>)
- High I<sub>FSM</sub> capability
- · High power density
- · Reduced system costs
- System miniaturization
- Reduced EMI

### 3. Applications

- Switch mode power Supply (SMPS)
- AC-DC and DC-DC converter
- · Battery charging infrastructure
- Server and telecom power supply
- Uninterruptible power supply (UPS)
- Photovoltaic inverters

#### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
I <sub>F</sub>	forward current	$T_c \le 120$ °C; δ = 1		-	-	16	Α	
Static characte	ristics							
$V_{DC}$	DC blocking voltage			650	-	-	V	
Dynamic chara	Dynamic characteristics							
$Q_C$	total capacitive charge	$V_R = 400 \text{ V}; \text{ dI}_F/\text{dt} = 200 \text{ A/}\mu\text{s}; \text{ I}_F = 16 \text{ A}; $ $T_j = 25 ^{\circ}\text{C}$		-	34	-	nC	



### 650 V, 16 A SiC Schottky diode in D2PAK R2P

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	A	anode		
mb	К	mounting base; connected to cathode	D2PAK R2P (SOT8018)	K K; mb

# 6. Ordering information

**Table 3. Ordering information** 

Type number	Package	•				
	Name	Description	Version			
<u>PSC1665J</u>	D2PAK R2P	Plastic, single-ended surface-mounted package (D2PAK R2P); Real-2-Pin configuration; 5.08 mm pitch; 8.8 mm x 10.35 mm x 4.46 mm body	SOT8018			

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PSC1665J	PSC1665J

### 650 V, 16 A SiC Schottky diode in D2PAK R2P

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage	T <sub>j</sub> = 25 °C	-	650	V
dv/dt	diode dv/dt ruggedness	0 V ≤ V <sub>R</sub> ≤ 480 V	-	100	V/ns
I <sub>F</sub>	forward current	T <sub>c</sub> ≤ 120 °C; δ = 1	-	16	А
I <sub>FSM</sub>	non-repetitive peak	t <sub>p</sub> = 10 μs; square wave; T <sub>c</sub> = 25 °C	-	650	Α
	forward current	t <sub>p</sub> = 10 ms; half sine-wave; T <sub>c</sub> = 25 °C	-	80	А
		t <sub>p</sub> = 10 ms; half sine-wave; T <sub>c</sub> = 150 °C	-	65	А
∫i <sup>2</sup> dt	i <sup>2</sup> t value	t <sub>p</sub> = 10 ms; T <sub>c</sub> = 25 °C	-	32	A²s
		t <sub>p</sub> = 10 ms; T <sub>c</sub> = 150 °C	-	21	A²s
P <sub>tot</sub>	total power dissipation	T <sub>c</sub> ≤ 25 °C	-	90	W
Tj	junction temperature		-55	175	°C
T <sub>amb</sub>	ambient temperature		-55	175	°C
T <sub>stg</sub>	storage temperature		-65	175	°C

#### 650 V, 16 A SiC Schottky diode in D2PAK R2P

### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-c)}$	thermal resistance from junction to case		-	1.3	1.7	K/W

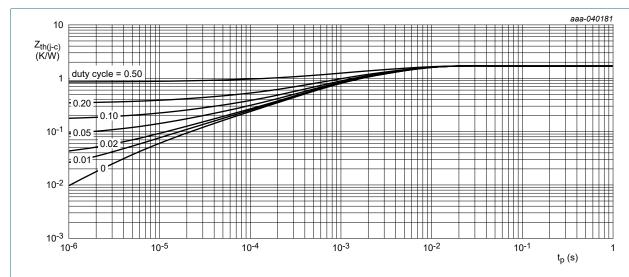


Fig. 1. Transient thermal impedance as a function of pulse duration; maximum values

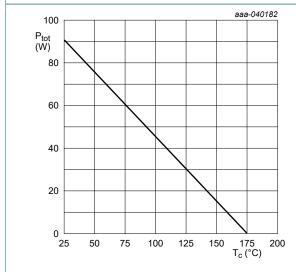


Fig. 2. Power dissipation; maximum values

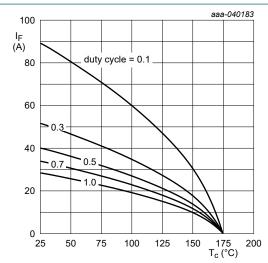


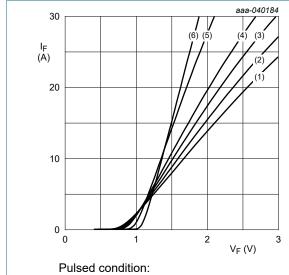
Fig. 3. Forward current as a function of case temperature; maximum values

#### 650 V, 16 A SiC Schottky diode in D2PAK R2P

### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics			I		
$V_{DC}$	DC blocking voltage		650	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 16 A; T <sub>j</sub> = 25 °C	-	1.5	1.8	V
		I <sub>F</sub> = 16 A; T <sub>j</sub> = 150 °C	-	2	2.6	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 650 V; T <sub>j</sub> = 25 °C	-	1	180	μΑ
		V <sub>R</sub> = 650 V; T <sub>j</sub> = 150 °C	-	10	1250	μΑ
Dynamic ch	naracteristics					
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	475	-	pF
		V <sub>R</sub> = 400 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	61	-	pF
Q <sub>C</sub>	total capacitive charge	$V_R = 400 \text{ V}; \text{ dI}_F/\text{dt} = 200 \text{ A/}\mu\text{s}; \text{ I}_F = 16 \text{ A};$ $T_i = 25 ^{\circ}\text{C}$	-	34	-	nC





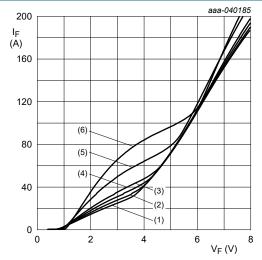
$$(2) T_i = 150 °C$$

(3) 
$$T_i = 125 \,^{\circ}\text{C}$$

$$(4)$$
 T<sub>i</sub> = 100 °C

(6) 
$$T_i = -55 \,^{\circ}\text{C}$$

Forward current as a function of forward Fig. 4. voltage; typical values



#### Pulsed condition:

(1) 
$$T_j = 175$$
 °C

(2) 
$$T_i = 150 \,^{\circ}\text{C}$$

(2) 
$$T_j = 150 \,^{\circ}\text{C}$$
  
(3)  $T_j = 125 \,^{\circ}\text{C}$ 

$$(4) T_j = 100 °C$$

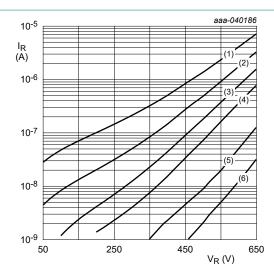
$$(5) T_j = 25 °C$$

$$(6)$$
  $T_j = -55$  °C

Forward characteristics in surge current as a Fig. 5. function of forward voltage; typical values

600

#### 650 V, 16 A SiC Schottky diode in D2PAK R2P



Pulsed condition:

(1)  $T_j = 175 \, ^{\circ}C$ 

(2)  $T_j = 150 \,^{\circ}\text{C}$ (3)  $T_j = 125 \,^{\circ}\text{C}$ (4)  $T_j = 100 \,^{\circ}\text{C}$ 

(5)  $T_i = 25 °C$ 

 $(6) T_i = -55 °C$ 

Fig. 6. Reverse current as a function of reverse voltage; typical values

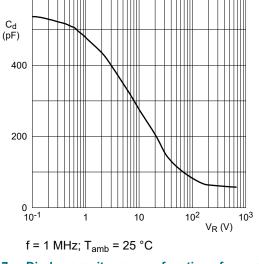


Fig. 7. Diode capacitance as a function of reverse voltage; typical values

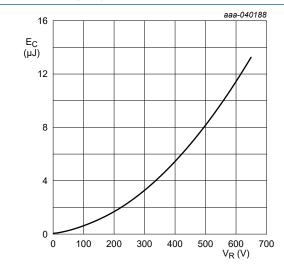
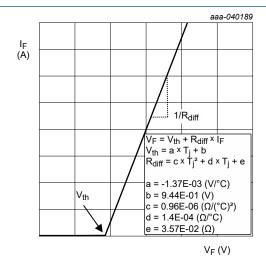


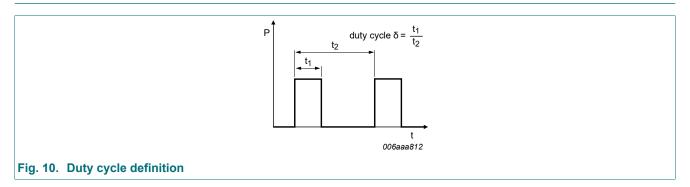
Fig. 8. Capacitance stored energy as a function of reverse voltage; typical values



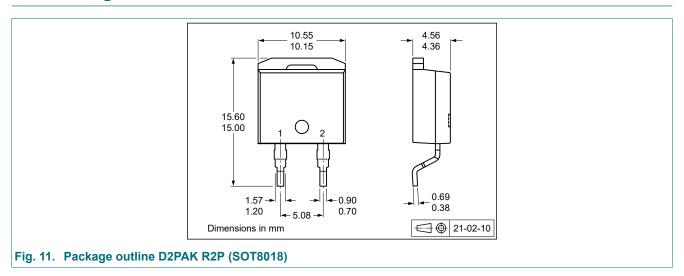
Simplified forward characteristics mode

#### 650 V, 16 A SiC Schottky diode in D2PAK R2P

## 11. Test information

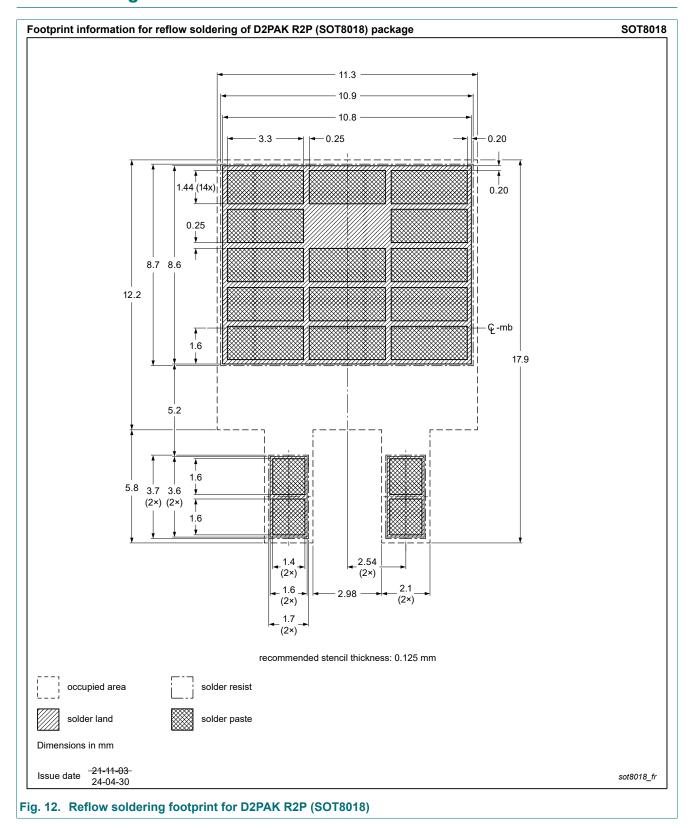


# 12. Package outline



#### 650 V, 16 A SiC Schottky diode in D2PAK R2P

# 13. Soldering



DCC466E I

## 650 V, 16 A SiC Schottky diode in D2PAK R2P

# 14. Revision history

#### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PSC1665J v.1	20240717	Product data sheet	-	-

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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PSC1665J

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### 650 V, 16 A SiC Schottky diode in D2PAK R2P

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